

## Power line chokes

Current-compensated E core double chokes  
250 V AC, 0.3 ... 1.8 A, 3.3 ... 100 mH, +40 °C

**Series/Type:**            **B82731T**

**Date:**                    February 2025

## Power line chokes

B82731T

### Current-compensated E core double chokes

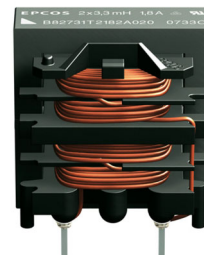
**Rated voltage 250 V AC**

**Rated current 0.3 ... 1.8 A**




**Nominal inductance 3.3 ... 100 mH**

#### Construction

- Current-compensated double choke
- Closed E ferrite core
- Closed PET coil former with 4 sections (UL 94 V-0)
- Without encapsulation
- 4-section winding
- Clearances > 2.5 mm, creepage distances > 3 mm



#### Features

- High resonance frequency due to 2-section winding
- High pulse strength
- Low whirring noise
- Approx. 2% stray inductance for symmetrical interference suppression
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2) and UL 1283
- UL and ENEC (VDE) approvals   
- RoHS-compatible

#### Applications

- Suppression of common-mode interferences
- Electronic ballasts for lamps
- Switch-mode power supplies for consumer electronics

#### Terminals

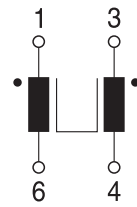
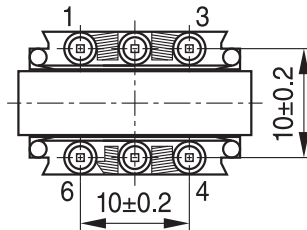
- Pins 0.64 × 0.64 (mm)
- Lead spacing 10 × 10 (mm)

#### Marking

Product brand, nominal inductance, rated current, approval signs, pin 1 indicator, ordering code, date of manufacture (YYWW), production place identification code

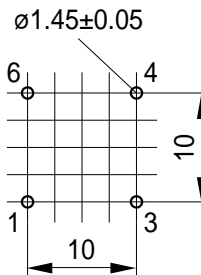
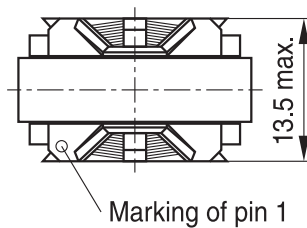
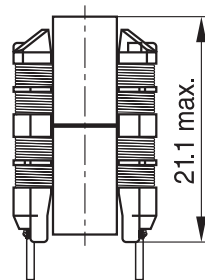
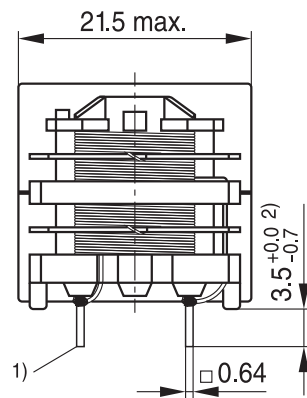
#### Delivery mode

- Blister tray in cardboard box

**Dimensional drawings and pin configurations**


No polarity

IND2410-H-E



Recommended hole arrangement  
(view in mounting direction)

IND0361-L-E

<sup>1)</sup> Tin tips permissible

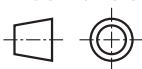
<sup>2)</sup> Dimension does not include tin tip

IND2420-D-E

Part tolerances to ISO 2768-c / ISO 8015.

Size ISO 14405  $\text{\textcircled{E}}$

All dimensions in mm





IND2140-B-E

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**Technical data and measuring conditions**

Rated voltage $V_R$	250 V AC (50/60 Hz)
Test voltage $V_{test}$	1500 V AC, 2 s (line/line)
Rated temperature $T_R$	+40 °C
Rated current $I_R$	Referred to 50 Hz and rated temperature
Nominal inductance $L_N$	Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C Inductance is specified per winding.
Inductance tolerance	−30/+50% at +20 °C
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with $I_R$ , +20 °C
Stray inductance $L_{stray,typ}$	Measured with Agilent 4284A at 5 mA, +20 °C, typical values
DC resistance $R_{typ}$	Measured at +20 °C, typical values, specified per winding
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 ±5) °C, (3 ±0.3) s Wetting of soldering area ≥ 95% (to IEC 60068-2-20, test Ta)
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)
Climatic category	40/125/56 (to IEC 60068-1)
Storage conditions (packaged)	−25 °C ... +40 °C, ≤ 75% RH
Weight	Approx. 15 g
Approvals	EN 60938-2, UL 1283

**Power line chokes**
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**Current-compensated E core double chokes**
**Characteristics and ordering codes**

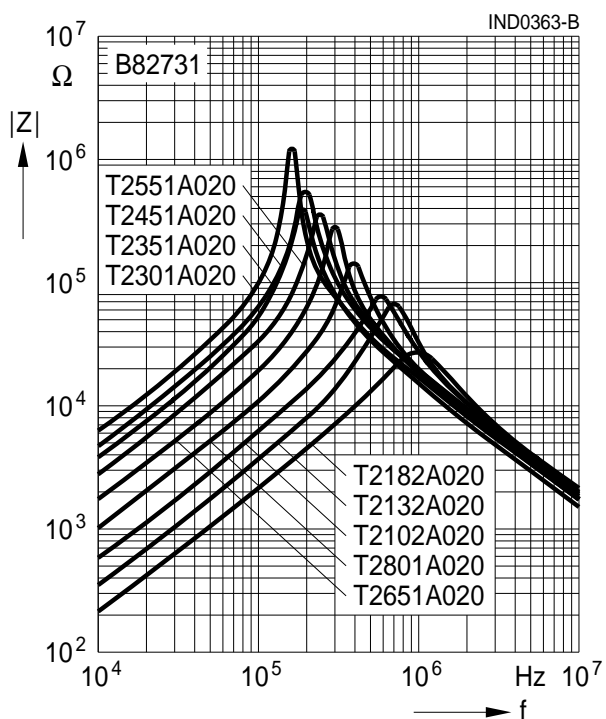
$I_R$ A	$L_N$ mH	$L_{\text{stray,typ}}$ $\mu\text{H}$	$R_{\text{typ}}$ $\text{m}\Omega$	Ordering code	Approvals	
						
0.30	100	2000	6600	B82731T2301A020	×	×
0.35	68	1300	4400	B82731T2351A020	×	×
0.45	47	950	2800	B82731T2451A020	×	×
0.55	39	800	2200	B82731T2551A020	×	×
0.65	27	550	1600	B82731T2651A020	×	×
0.8	15	300	950	B82731T2801A020	×	×
1.0	10	200	630	B82731T2102A020	×	×
1.3	6.8	140	370	B82731T2132A020	×	×
1.8	3.3	65	200	B82731T2182A020	×	×

× = approval granted

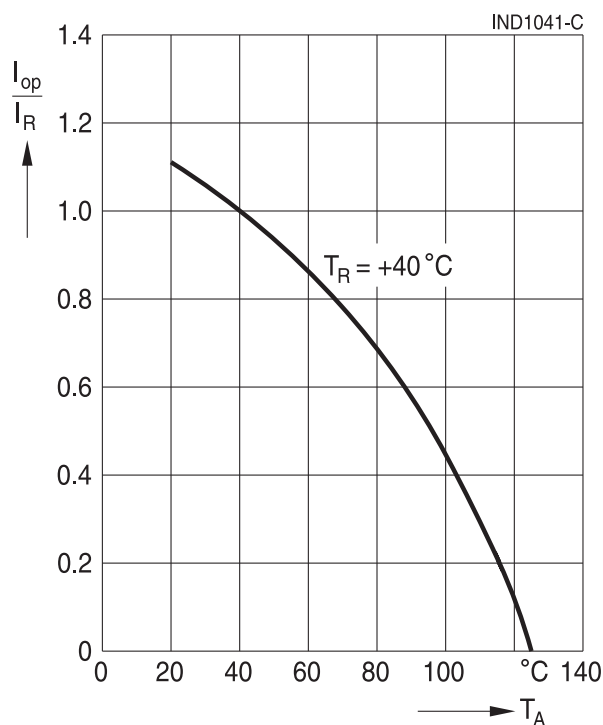
Sample kit available. Ordering code: B82731X002

For more information refer to chapter "Sample kits".

**Impedance  $|Z|$  versus frequency  $f$**   
measured with windings in parallel at +20 °C,  
typical values



**Current derating  $I_{op}/I_R$**   
**versus temperature  $T_A$**



## Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
  - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
  - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.  
 Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
  - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
  - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
  - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
  - If additional mechanical forces are applied to the component, e.g., application of gap pads, it is necessary to check whether they attack or destroy any part of the component.
  - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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## Cautions and warnings

### Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.** Detailed information can be found on the Internet under [www.tdk-electronics.tdk.com/orderingcodes](http://www.tdk-electronics.tdk.com/orderingcodes).



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The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
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## Important notes

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